- 3-State Outputs Drive Bus Lines Directly
- Encodes 8 Data Lines to 3-Line Binary (Octal)
- Applications Include: N-Bit Encoding Code Converters and Generators
- Typical Data Delay ... 15 ns
- Typical Power Dissipation . . . 60 mW

description

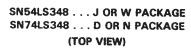
These TTL encoders feature priority decoding of the inputs to ensure that only the highest-order data line is encoded. The 'LS348 circuits encode eight data lines to three-line (4-2-1) binary (octal). Cascading circuitry (enable input E1 and enable output E0) has been provided to allow octal expansion. Outputs A0, A1, and A2 are implemented in three-state logic for easy expansion up to 64 lines without the need for external circuitry. See Typical Application Data.

FUNCTION TABLE

	INPUTS										JTPU	TS	
EI	0	1	2	3	4	5	6	7	A2	A1	AO	GS	EO
Н	х	Х	Х	Х	Х	Х	Х	X	Z	Z	Z	н	н
L	н	н	Н	н	н	Н	н	Н	z	Z	Z	н	L
L	х	Х	х	х	х	х	х	L	L	L	L	L	н
L	х	х	х	х	х	х	L	н	L	L	н	L	н
L	х	Х	х	х	х	L	н	н	L	н	L	L	н
L	X	х	х	х	L	Н	н	н	L	н	н	L	н
L	Ý	х	х	L	н	Н	н	н	н	L	L	L	н
L	х	х	L	н	н	н	н	н	н	L	н	L	н
L	х	L	Н	H,	н	н	н	Н	н	н	L	L	н
L	L	Н	н	н	Н	Н	н	Н	н	н	н	L	н

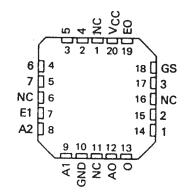
H = high logic level, L = low logic level, X = irrelevant

Z = high-impedance state



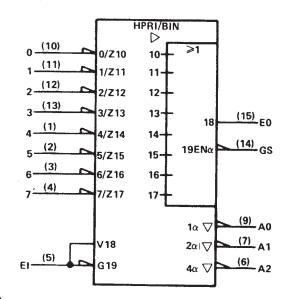
4 [5 [6 [7 [A2 [1 2 3 4 5 6	16 VCC 15 EO 14 GS 13 3 12 2 11 1
	6	
	8	





NC - No internal connection

logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

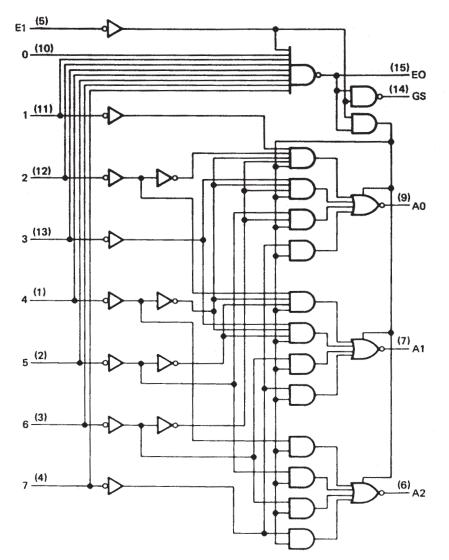
Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



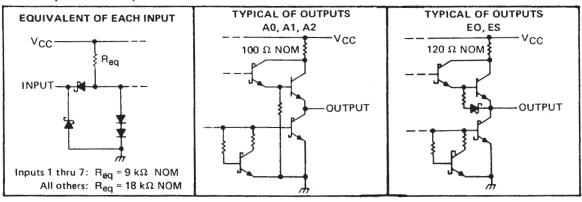
SN54LS348, SN74LS348 (TIM9908) 8-LINE TO 3-LINE PRIORITY ENCODERS WITH 3-STATE OUTPUTS SDLS161 – OCTOBER 1976 – REVISED MARCH 1988

logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

schematic of inputs and outputs





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		. 7 V
Input voltage	• • • • • • • • • • • • • • • • • • •	7V
Operating free-air temperature range	SN54LS348	55°C to 125°C
Storage temperature range	SN74LS348	65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SI	V54LS 3	48	SN74LS348			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5,25	V
High-level output current, IOH	A0, A1, A2			-1			-2.6	mA
	EO, GS			-400			-400	μA
Low-level output current, IOI	A0, A1, A2			12			24	mA
	EO, GS			4			8	mA
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS [†]			154LS3	348	SN74LS348			UNIT	
						TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIH	High-level input voltage	1. T		2			2			V		
VIL	Low-level input voltage						0.7			0.8	V	
Vik	Input clamp voltage		$V_{CC} = MIN,$	l ₁ =18 mA			-1.5			-1.5	V	
	High-level	A0, A1, A2	$V_{CC} = MIN,$	$I_{OH} = -1 \text{ mA}$	2.4	3.1						
Vou	output voltage	A0, A1, A2	V _{IH} = 2 V,	1 _{OH} = -2.6 mA				2.4	3.1		V	
	output vortage	EO, GS	VIL = VILmax	I _{OH} =400 μA	2.5	3.4		2.7	3.4			
		A0, A1, A2	V _{CC} = MIN,	I _{OL} = 12 mA		0.25	0.4		0.25	0.4		
VOL	Low-level	AV, A1, A2	$V_{1H} = 2 V$,	I _{OL} = 24 mA					0.35	0.5	v	
· OL	Output voltage	EO, GS		¹ OL = 4 mA		0.25	0.4		0.25	0.4	v	
		20, 33	VIL = VILmax	IOL = 8 mA					0.35	0.5		
loz	Off-State (high-impedance	A0, A1, A2	$V_{CC} = MAX,$	V _O = 2.7 V			20			20		
·02	state) output current	70, 71, 72	V _{IH} = 2 V	V _O = 0.4 V			-20			-20	μA	
łı.	Input current at maximum	Inputs 1 thru 7	Vcc = MAX,	V. ~ 7 V			0.2			0.2		
·1	input voltage	All other inputs	VCC - MAA,	vi- / v			0.1			0.1	mA	
Чн	High-level input current	Inputs 1 thru 7	$V_{CC} = MAX_{t}$	V 27V			40			40		
.11	rightever input current	All other inputs	VCC - MAA,	V] = 2.7 V			20			20	μA	
HL	Low-level input current	Inputs 1 thru 7					0.8			-0.8		
·1L		All other inputs	$V_{CC} = MAX,$	V] = 0.4 V			-0.4			-0.4	mΑ	
los	Short-circuit output current §	Outputs A0, A1, A2	V MAX	· · · · · · · · · · · · · · · · · · ·	-30		-130	-30		-130		
03	enore on our output cultents	Outputs EO, GS	V _{CC} = MAX		-20		-100	-20		-100	mA	
Icc	Supply current		$V_{CC} = MAX,$	Condition 1		13	25		13	25		
CC Supply current			See Note 2	Condition 2		12	23		12	23	mA	

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ} C$.

\$Not more than one output should be shorted at a time.

NOTE 2: I_{CC} (condition 1) is measured with inputs 7 and El grounded, other inputs and outputs open. I_{CC} (condition 2) is measured with all inputs and outputs open.



SN54LS348, SN74LS348 (TIM9908) 8-LINE TO 3-LINE PRIORITY ENCODERS WITH 3-STATE OUTPUTS

SDLS161 - OCTOBER 1976 - REVISED MARCH 1988

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

PARAMETER [†]	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	түр	MAX	UNIT
ሞLH	1 thru 7	A0, A1, or A2	In-phase		11	. 11	17	ns
tPHL.		AU, AT, OF A2	output	CLARAE -E		20	30	115
ΨLH	1 thru 7	A0, A1, or A2	Out-of-phase	CL ≈ 45 pF,		23	35	ns
THE		AU, AT, 01 AZ	output	RL = 667 Ω, See Note 3		23	35	ns
ФZH	EI	A0, A1, or A2		See NOLE 2		25	39	ns
ሞZL						24	41	
TPLH	0 thru 7	EO	Out-of-phase			11	18	ns
t PHL		20	output			26	40	113
tPLH	0 thru 7	GS	In-phase	CL = 15 pF		38	55	ns
tPHL	o and 7	60	output	CL=15βF RL=2kΩ,		9	21	
tPLH	EI	GS	In-phase	See Note 3		11	17	ns
tPHL] []	00	output	See Note S		14	36	
ΨLH	EI	EO	In-phase			17	26	ns
tPHL	1 -	20	output			25	40	115
tPHZ	EI	A0, A1, or A2		СL = 5 рF		18	27	
ሞLZ] ['	AV, A1, 01 A2		RL = 667 Ω		23	35	ns

[†] t_{PLH} = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

 t_{PZH} = output enable time to high level

tpzL = output enable time to low level

tpHZ = output disable time from high level

tpLZ = output disable time from low level

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TYPICAL APPLICATION DATA

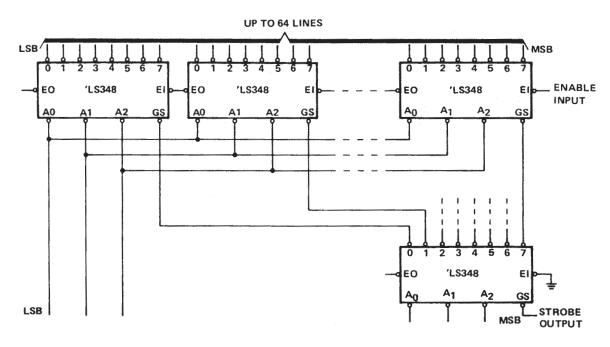


FIGURE 1-PRIORITY ENCODER WITH UP TO 64 INPUTS.





10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS348D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS348	Samples
SN74LS348N	ACTIVE	PDIP	Ν	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS348N	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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5-Jan-2022

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SN74LS348D	D	SOIC	16	40	507	8	3940	4.32
SN74LS348N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS348N	Ν	PDIP	16	25	506	13.97	11230	4.32

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



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D (R-PDSO-G16) PLASTIC SMALL OUTLINE Stencil Openings (Note D) Example Board Layout (Note C) –16x0,55 -14x1,27 -14x1,27 16x1,50 5,40 5.40 Example Non Soldermask Defined Pad Example Pad Geometry (See Note C) 0,60 .55 Example 1. Solder Mask Opening (See Note E) -0,07 All Around

NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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